

**Dual 8A High-Speed, High-Efficiency
 Epitaxial Silicon Rectifiers**

August 1991

T-23-07
Features

- Ultrafast Recovery Time ($t_{rr} < 35\text{ns}$)
- Low Forward Voltage
- Low Thermal Resistance
- Planar Design
- Wire-Bonded Construction

Applications

- General Purpose
- Power Switching Circuits to 100kHz
- Full-Wave Rectification

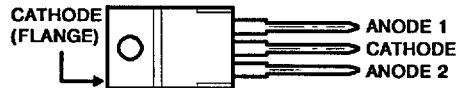
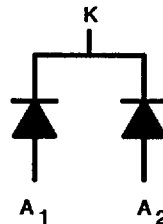
Description

The RURD810, RURD815, RURD820 are low forward voltage drop ultrafast rectifiers ($t_{rr} < 35\text{ns}$). They use a glass passivated ion-implanted, epitaxial construction.

These devices are intended for use as output rectifiers and flywheel diodes in a variety of high frequency pulse width modulated and switching regulators. Their low stored charge and attendant fast reverse recovery behavior minimize electrical noise generation and in many circuits markedly reduce the turn-on dissipation of the associated power switching transistors.

All are supplied in TO-220AB plastic packages.

Package

 TO-220AB
 TOP VIEW

Symbol

Absolute Maximum Ratings ($T_C = +25^\circ\text{C}$)

	RURD810	RURD815	RURD820
Peak Repetitive Reverse Voltage..... V_{RRM}	100V	150V	200V
Average Rectified Forward Current			
$T_A = 25^\circ\text{C}$ (No Heat Sink)..... $I_{F(AV)}$	3A	3A	3A
$T_A = 25^\circ\text{C}$ (With Heat Sink)*..... $I_{F(AV)}$	8A	8A	8A
$T_A = 125^\circ\text{C}$ $I_{F(AV)}$	8A	8A	8A
Nonrepetitive Peak Surge Current..... I_{FSM} (8.3ms, 1/2 cycle)	100A	100A	100A
Operating and Storage Temperature..... T_{STG}, T_J	-55°C to $+175^\circ\text{C}$	-55°C to $+175^\circ\text{C}$	-55°C to $+175^\circ\text{C}$
Maximum Lead Temperature During Solder..... T_L (At distance $> 1/8"$ (3.17mm) from case or 10s max)	260°C	260°C	260°C

*Wakefield type 295 heat sink with convection cooling.

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 ULTRA-FAST
 RECTIFIERS

Electrical Characteristics ($T_C = +25^\circ\text{C}$) Unless Otherwise Specified.

T-23-07

SYMBOL	TEST CONDITION	LIMITS									UNITS
		RURD810			RURD815			RURD820			
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
V_F	$I_F = 8\text{A}$ $T_C = +150^\circ\text{C}$	-	-	0.83	-	-	0.83	-	-	0.85	V
	$I_F = 8\text{A}$ $T_C = +25^\circ\text{C}$	-	-	0.975	-	-	0.975	-	-	1	V
$I_R @$ $T_C = +150^\circ\text{C}$	$V_R = 100\text{V}$	-	-	250	-	-	-	-	-	-	μA
	$V_R = 150\text{V}$	-	-	-	-	-	250	-	-	-	μA
	$V_R = 200\text{V}$	-	-	-	-	-	-	-	-	250	μA
$I_R @$ $T_C = +25^\circ\text{C}$	$V_R = 100\text{V}$	-	-	5	-	-	-	-	-	-	μA
	$V_R = 150\text{V}$	-	-	-	-	-	5	-	-	-	μA
	$V_R = 200\text{V}$	-	-	-	-	-	-	-	-	5	μA
t_{rr}	$I_F = 8\text{A}^*$	-	-	35	-	-	35	-	-	35	ns
$R_{\theta jc}$		-	-	2.25	-	-	2.25	-	-	2.25	$^\circ\text{C}/\text{W}$
$R_{\theta ja}$		-	-	60	-	-	60	-	-	60	$^\circ\text{C}/\text{W}$
C_J	$V_R = 10\text{V}$ $I_F = 0\text{A}$	-	40	-	-	40	-	-	40	-	pF

* $di_F/dt = 40\text{A}/\mu\text{s}$, $I_{RM}(\text{rec}) < 1\text{A}$, $I_{RR} = 0.25\text{A}$.

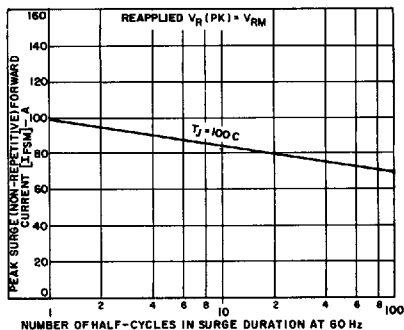


FIGURE 1. PEAK SURGE FORWARD CURRENT vs SURGE DURATION

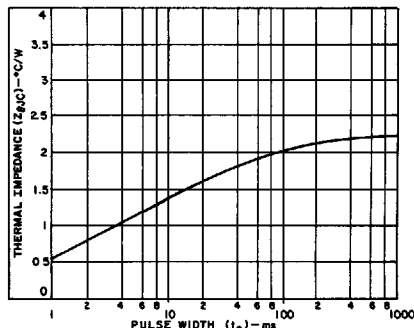


FIGURE 2. THERMAL IMPEDANCE vs PULSE WIDTH (PER JUNCTION)

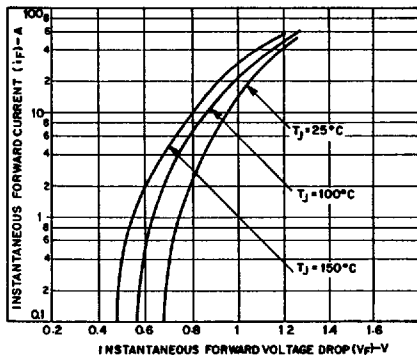


FIGURE 3. TYPICAL FORWARD CURRENT vs FORWARD VOLTAGE DROP

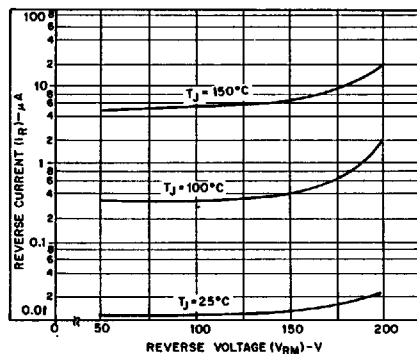


FIGURE 4. TYPICAL REVERSE CURRENT vs VOLTAGE